

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1" style="width: 100%; border-collapse: collapse;"> <thead> <tr> <th style="width: 70%;">Name</th> <th style="width: 30%;">Execution Date</th> </tr> </thead> <tbody> <tr> <td>Noren Pan</td> <td>02/25/2010</td> </tr> <tr> <td>Christopher Youtsey</td> <td>02/24/2010</td> </tr> <tr> <td>David S. McCallum</td> <td>02/25/2010</td> </tr> <tr> <td>Victor C. Elarde</td> <td>02/24/2010</td> </tr> <tr> <td>John M. Dallesasse</td> <td>02/24/2010</td> </tr> </tbody> </table>		Name	Execution Date	Noren Pan	02/25/2010	Christopher Youtsey	02/24/2010	David S. McCallum	02/25/2010	Victor C. Elarde	02/24/2010	John M. Dallesasse	02/24/2010
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<table border="1" style="width: 100%; border-collapse: collapse;"> <tr> <td style="width: 20%;">Name:</td> <td>MicorLink Devices, Inc.</td> </tr> <tr> <td>Street Address:</td> <td>6457 W. Howard Street</td> </tr> <tr> <td>City:</td> <td>Niles</td> </tr> <tr> <td>State/Country:</td> <td>ILLINOIS</td> </tr> <tr> <td>Postal Code:</td> <td>60714</td> </tr> </table>		Name:	MicorLink Devices, Inc.	Street Address:	6457 W. Howard Street	City:	Niles	State/Country:	ILLINOIS	Postal Code:	60714		
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CORRESPONDENCE DATA													
<p>Fax Number: (617)742-4214 <i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i></p> <p>Phone: 617-227-7400 Email: nlt@lahive.com</p> <p>Correspondent Name: Anthony A. Laurentano Address Line 1: One Post Office Square, Floor 30 Address Line 2: Lahive & Cockfield, LLP Address Line 4: Boston, MASSACHUSETTS 02109</p>													
ATTORNEY DOCKET NUMBER:	MLW-015												
NAME OF SUBMITTER:	Anthony A. Laurentano												

CH \$40.00 12695671

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PATENT
REEL: 024071 FRAME: 0686

Total Attachments: 7

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ASSIGNMENT BY INVENTORS

WE, Noren PAN; Christopher YOUTSEY; David S. MCCALLUM; Victor C. ELARDE; and John M. DALLESSASSE, of Wilmette, Illinois; Libertyville, Illinois; West Chicago, Illinois; Evanston, Illinois; and Niles, Illinois, respectively, in consideration of One Dollar and other valuable consideration paid to us by

MicroLink Devices, Inc.

a of Corporation of Delaware, having its principal place of business at 6457 W. Howard Street, Niles, Illinois 60714, the receipt of which is hereby acknowledged, do hereby sell, assign and transfer unto said

MicroLink Devices, Inc.

its successors and assigns, the entire interest for the United States of America and all foreign countries including all rights of priority under the International Convention for the Protection of Industrial Property in a certain invention or improvement in

HIGH EFFICIENCY GROUP III-V COMPOUND SEMICONDUCTOR SOLAR CELL WITH OXIDIZED WINDOW LAYER

described in an application

☐ Executed by us of even date herewith and about to be filed

or

☒ Application No. 12/695,671, filed on January 28, 2010

This application claims the benefit of the following provisional application(s):

☒ Provisional Application No. 61/147929, filed on January 28, 2009


in the United States Patent and Trademark Office, and in all Letters Patent of the United States and all foreign countries which may or shall be granted on said invention, or any parts thereof, or on said application, or any divisional, continuing, reissue or other applications based in whole or in part thereon. And we agree, for ourselves and our executors and administrators, with said Corporation and its successors and assigns but at its or their expense and charges, hereafter to execute all applications, amended specifications, deed or other instrument, and to do all acts necessary or proper to secure the grant of Letters Patent in the United States and in all other countries to said Corporation, with specifications and claims in such form as shall be

approved by the counsel of said Coproration and to vest and confirm in said Coproration, its successors and assigns, the legal title to all such patents.

And we do hereby authorize and request the Commissioner of Patents and Trademarks of the United States to issue such Letters Patent as shall be granted upon said application or applications based thereon to said assignee, its successors and assigns.

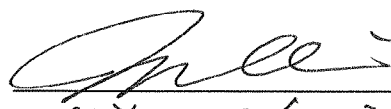
And we do further hereby grant the attorneys/agents of Lahive & Cockfield, LLP, the power to insert on this Assignment the filing date and/or application number of said application.

2/25/2010
Date

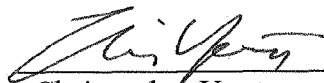

Noren Pan

Witness:

2/25/2010
Date

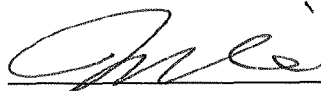

Mitsuyo Levin

2/24/10
Date


Christopher Youtsey

Witness:

2/24/10
Date


Mitsuyo O. Louren.

02/25/10
Date

David S McCallum
David S. McCallum

Witness:

2/25/10
Date


Mike
Mitsuyo Leuten

2/24/2010
Date

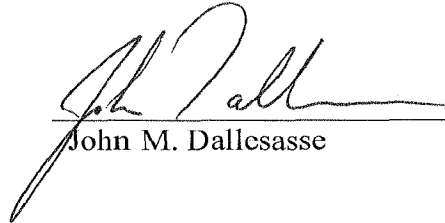

Victor C. Elarde

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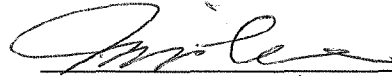

Witness

2/24/10
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John M. Dallesasse

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2/24/10
Date


Mitsye Louder